NCE N-Channel Enhancement Mode Power MOSFET

Description

The NCE6005AS uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications.

General Features

V_{DS}=60V,I_D=5A

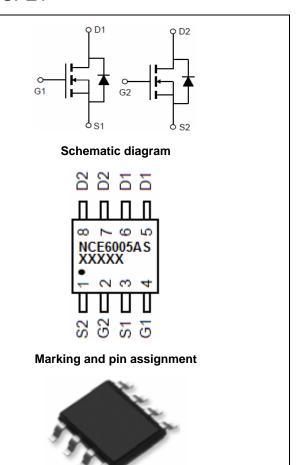
 $R_{DS(ON)}$ <35m Ω @ V_{GS} =10V (Typ.26m Ω)

 $R_{DS(ON)}$ <45m Ω @ V_{GS} =4.5V (Typ.32m Ω)

- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Good stability and uniformity with high E_{AS}
- Excellent package for good heat dissipation

Application

- Power switching application
- Hard switched and high frequency circuits
- Uninterruptible power supply



SOP-8 top view

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE6005AS	NCE6005AS	SOP-8	Ø330mm	12mm	4000 units

Absolute Maximum Ratings (T_A=25℃unless otherwise noted)

<u> </u>			
Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V _{DS}	60	V
Gate-Source Voltage	V _G s	±20	V
Drain Current-Continuous	I _D	5	А
Drain Current-Continuous(T _C =100℃)	I _D (100℃)	3.5	Α
Pulsed Drain Current	I _{DM}	24	Α
Maximum Power Dissipation	P _D	2	W
Operating Junction and Storage Temperature Range	T_{J}, T_{STG}	-55 To 150	$^{\circ}$ C

Thermal Characteristic

Thermal Resistance, Junction-to-Ambient (Note 2)	$R_{ hetaJA}$	62.5	°C/W

NCE6005AS

Electrical Characteristics (T_A =25 $^{\circ}$ Cunless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics			•	•		
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250μA	60	-	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =60V,V _{GS} =0V	-	-	1	μΑ
Gate-Body Leakage Current	I _{GSS}	V_{GS} =±20 V , V_{DS} =0 V	-	-	±100	nA
On Characteristics (Note 3)			•	•		
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}$, $I_{D}=250\mu A$	1.2	1.6	2.5	V
·	R _{DS(ON)}	V _{GS} =10V, I _D =5A	-	26	35	mΩ
Drain-Source On-State Resistance	$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	-	32	45	mΩ	
Forward Transconductance	g FS	V _{DS} =5V,I _D =5A	11	-	-	S
Dynamic Characteristics (Note4)			•	Į.		
Input Capacitance	C _{lss}	V 20V/V 0V	-	979	-	PF
Output Capacitance	Coss		-	120	-	PF
Reverse Transfer Capacitance	C _{rss}	F=1.UMHZ	-	100	-	PF
Switching Characteristics (Note 4)			•	Į.		
Turn-on Delay Time	t _{d(on)}		-	5.2	-	nS
Turn-on Rise Time	t _r	V_{DD} =30V, R_L =6.7 Ω	-	3	-	nS
Turn-Off Delay Time	$t_{d(off)}$	V_{GS} =10 V , R_{G} =3 Ω	-	17	-	nS
Turn-Off Fall Time	t _f		-	2.5	-	nS
Total Gate Charge	Q_g)/ 00)/I 5A	-	22		nC
Gate-Source Charge	Q _{gs}	$V_{DS}=30V,I_{D}=5A,$	-	3.3		nC
Gate-Drain Charge	Q_{gd}	V _{GS} =10V		5.2		nC
Drain-Source Diode Characteristics			•	Į.		
Diode Forward Voltage (Note 3)	V_{SD}	V _{GS} =0V,I _S =5A	-		1.2	V
Diode Forward Current (Note 2)	Is		-	-	5	Α
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD)				y LS+LD)

Notes:

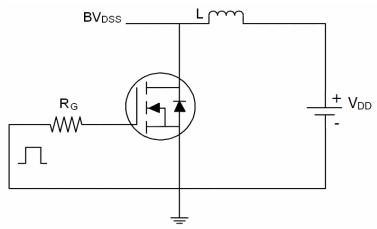
- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board, t ≤ 10 sec.
- 3. Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 2%.
- 4. Guaranteed by design, not subject to production
- 5. EAS condition:Tj=25 $^{\circ}\text{C}$,VDD=30V,VG=10V,L=0.5mH,Rg=25 Ω



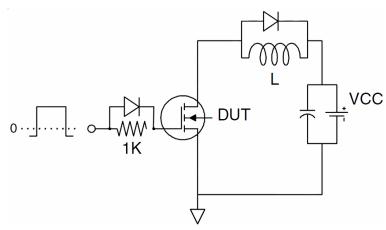
NCE6005AS

Test Circuit

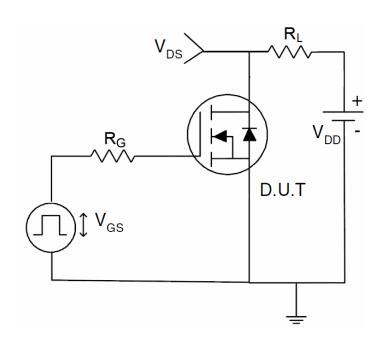
1) E_{AS} test Circuit



2) Gate charge test Circuit



3) Switch Time Test Circuit



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Typical Electrical and Thermal Characteristics (Curves)

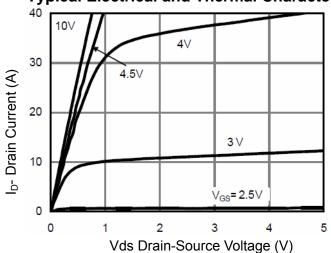


Figure 1 Output Characteristics

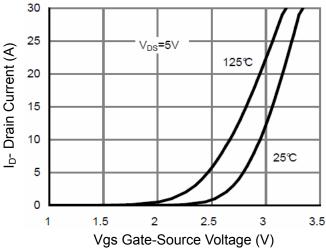


Figure 2 Transfer Characteristics

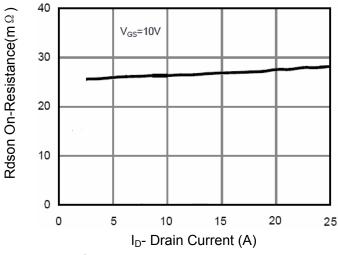


Figure 3 Rdson- Drain Current

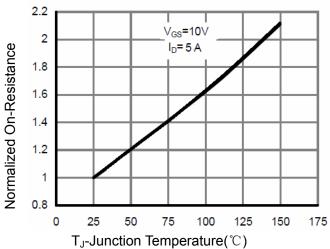


Figure 4 Rdson-Junction Temperature

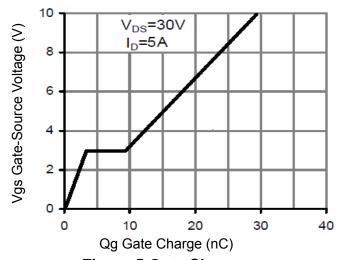


Figure 5 Gate Charge

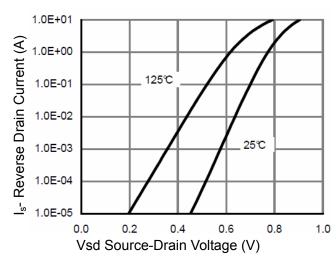
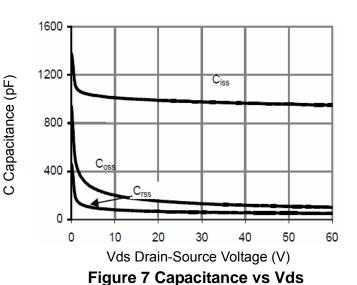


Figure 6 Source- Drain Diode Forward

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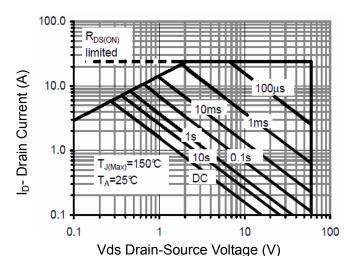


Figure 8 Safe Operation Area

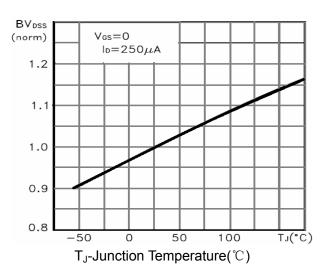


Figure 9 BV_{DSS} vs Junction Temperature

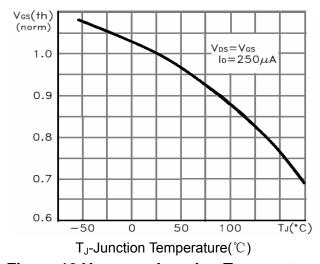


Figure 10 V_{GS(th)} vs Junction Temperature

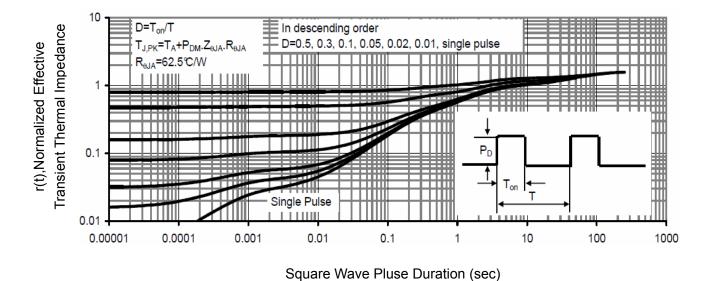
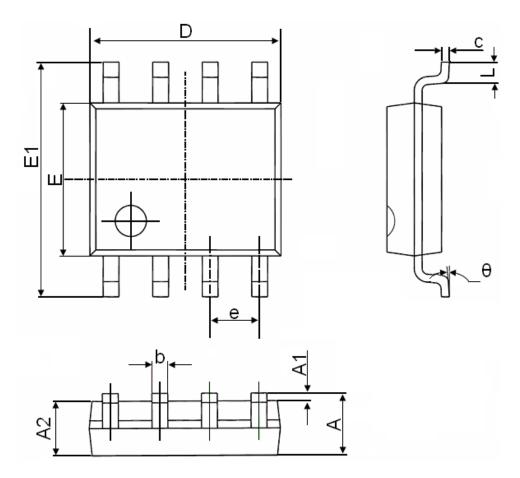


Figure 11 Normalized Maximum Transient Thermal Impedance

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SOP-8 Package Information



Symbol	Dimensions	In Millimeters	Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
Α	1.350	1.750	0.053	0.069	
A1	0.100	0.250	0.004	0.010	
A2	1.350	1.550	0.053	0.061	
b	0.330	0.510	0.013	0.020	
С	0.170	0.250	0.006	0.010	
D	4.700	5.100	0.185	0.200	
E	3.800	4.000	0.150	0.157	
E1	5.800	6.200	0.228	0.244	
е	1.270(BSC)		0.050(BSC)		
L	0.400	1.270	0.016	0.050	
θ	0°	8°	0°	8°	



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NCE6005AS

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